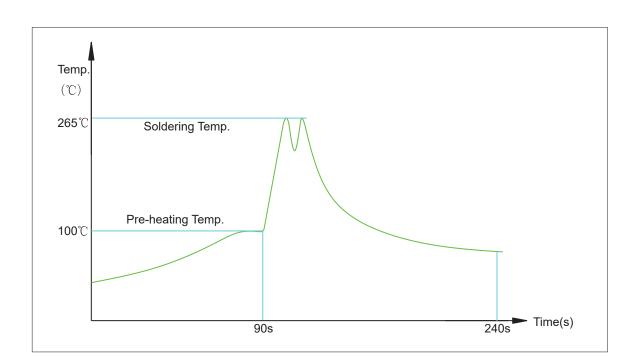


Suggested Profile of Wave Solder for RoHS products



- 1. Maximum soldering temperature: 265°C
- 2. Maximum soldering time: 5 seconds
- 3. SnAgCu or SAC, melting point is 219 °C
- 4. Any plastic components located under the Printed Circuit Board / Printed Wiring Board surface might be very slightly melted by recommended temperature profile. It will however, not affect the connector function. (For example, the plastic pins of the connector)

LABS Technology & Value	Unless Specified, Tolerance:	.x ± .35 .xx ± .25 .xxx ± .10	Approved By: TSLee		
	10G BASE- T, Tab-UP, Single, Shielded		Part No: WRJ-G111804ANL		REV. A
Drafted by:ZhangXian				SHEET 3 (OF 4
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